## 503584001 11/24/2015 PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:			NEW ASSIGNMENT		
NATURE OF CONVEYANCE:			ASSIGNMENT		
CONVEYING PARTY	DATA				
			Name	Execution Date	
KATSUYA SHIMIZU				10/26/2015	
RECEIVING PARTY	ΟΑΤΑ				
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City:	HIGAS	нон			
State/Country:	JAPAN	1			
Postal Code:	527-01	527-0125			
PROPERTY NUMBER	29 Total: 1				
Property Type			Number		
		1489	14893715		
CORRESPONDENCE	DATA				
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SIGNATURE:		/Daniel P. Lent/			
SIGNATURE:	DATE SIGNED:		11/24/2015		
			11/24/2015		
			11/24/2015		
DATE SIGNED:	e1.tif		11/24/2013		

## ASSIGNMENT

WHEREAS I/We, <u>Katsuva SHIMIZU</u> (hereinafter referred to as "ASSIGNORS") of c/o KYOWA INDUSTRY CO., LTD., 1790, Kotakari-cho, Higashiohmi-shi, Shiga 527-0125 Japan have invented certain new and useful improvements in:

## FLANGE JOINING STRUCTURE AND SEAL BODY USED THEREIN

which claims priority to <u>Japanese</u> Application No. <u>2013-115055</u>, filed <u>May 31, 2013</u>, and for which I am about to file or have filed an application for Letters Patent of the United States;

AND WHEREAS, **KYOWA INDUSTRY CO.**, **LTD.** (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of Japan, having a place of business at <u>1790, Kotakari-cho, Higashiohmi-shi, Shiga 527-0125 Japan</u>, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, I, the said ASSIGNOR have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention, the applications, and any and all patents that may be issued therefrom, in the United States and in all foreign countries, including any and all revivals, refilings, continuations, continuations-in part, divisions, and reissues thereof, to the said ASSIGNEE; and I, the ASSIGNOR, do hereby agree that I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that I will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications.

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like

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so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: October 26 .2015

SHIMIZU Katsuya SHIMIZU

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**RECORDED: 11/24/2015**